# Changkun LIU

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## **EDUCATION**

HKUST Sept. 2021 - now

PhD in Computer Science and Engineering

Shanghai Jiao Tong University (SJTU) Sept.2017 - Jun.2021

Bachelor of Engineering in Electronic Science and Technology

Summer Exchange Study: University of Washington (Seattle)

July 2019 - Aug. 2019

• Major in Electrical and Computer Engineering

#### **ACADEMIC RESEARCHES**

#### Real-time system task scheduling

Apr. 2020- June 2021

A conference paper is under review. (The only first author)

#### **INTERNSHIP**

#### Intel Asia-Pacific R&D Ltd.

Jun 2020 - May 2021

Software Engineer Intern, Dept. of IST, IOTG

• Participate in the function improvement and development of an Open source project StarlingX as the only intern in the StarlingX Team and the only undergraduate intern in IST department

## **HONORS & AWARDS**

Honorable Mention of 2019 Mathematical Contest in Modeling — International-class Top 25%	Oct. 2019
Class C Scholarship of SJTU	2018
Class C Scholarship of SJTU	2019
Class B Scholarship of SJTU	2020
Second-Class Scholarship Awarded by SCSK, Kabuskiki Kaisha. Top 4%	2020
Outstanding Graduate of Shanghai Jiao Tong University	2021

## **TECHNICAL SKILLS**

- Programming languages: C, C#, Python, C++, Java
- Engineering tools: MATLAB, Unity, Ansible, Git, Latex